ASSOCIATION CONNECTING ELECTRODUCES INDUSTRIES INDUSTRIES International and Pan-Am	Bannockburn, Illii	inois. All rights reserved un	nder both This docu level parts	ment is a dec s, the declara	claration tion enc	n of the substances compasses all low	s within the manufactur er level materials for wl	er listed ite	m. Note: if th nufacturer ha	e item is an ass s engineering r	embly with lower esponsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form http://www.ipc.org/IPC-175x Dist							als and Mfg Information				
Supplier Information												
Company name*	pany unique ID	ae ID Unique			ique ID Authority			Response Date*				
nsemi								2024-05-16				
Contact Name	ame Title - Contact			Phone - Contact*				Email - Contact*				
Product-Env-Stewards	Env-Stewards Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
uthorized Representative* Title - Representative				Phone - Representative*				Email - Representative*				
Product-Env-Stewards Product Enviro Com			Compliance NA			I			Product-Env-Stewards@onsemi.com			
Requester Item Number	Mfr Item Numbe	er Mfr Item Name		Effective	Date	Version	Manufacturing Site		eight*	UOM	Unit Type	
	NCP1612A1DR2G Enhanced, High- Controller in SO		Efficiency Power Factor C10, Vcc 10.5V, VBUV 1	v 2024-05-	16 PH1		74	4.7	mg	Each		
Manufacturing Proccess Information												
Terminal Plating / Grid Array Materia	g / Grid Array Material Terminal Base Alloy		-STD-020 MSL Rating	Peak Process Body Temperature Max		are Max Time at Peak	Temperatu	re Number	of Reflow Cycl	es		
Matte Tin (Sn) - annealed CU Alloy		y 1	[	260		С	30	second	s 3			
Comments												
level 1 - maximum time at peak temperature d	uring soldering i	is 10-30 seconds										
For more information regarding material com	position please r	refer to page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl ohthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted					
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

	cable [E] enter the weigh			ance category (JIG or Requester) or enter a [F] Optionally enter the positive (+) and n				
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.24	mg	Supplier	Silicon (Si)	7440-21-3		1.24	mg
Die Attach	0.1	mg	Supplier	Silver (Ag)	7440-22-4		0.075	mg
			Supplier	Epoxy resins	129915-35-1		0.025	mg
Lead Frame	15.95	mg	Supplier	Silver (Ag)	7440-22-4		0.335	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0319	mg
			Supplier	Iron (Fe)	7439-89-6		0.3988	mg
			Supplier	Copper (Cu)	7440-50-8		15.1844	mg
Mold Compound-Black	55.41	mg		Epoxy resin	proprietary data		2.7705	mg
			Supplier	Phenolic Resin	Proprietary Data		2.7705	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		1.1082	mg
			Supplier	Carbon Black (C)	1333-86-4		0.277	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		48.4837	mg
Plating	1.89	mg	Supplier	Tin (Sn)	7440-31-5		1.89	mg
Wire Bond - Au	0.11	mg	Supplier	Gold (Au)	7440-57-5		0.11	mg